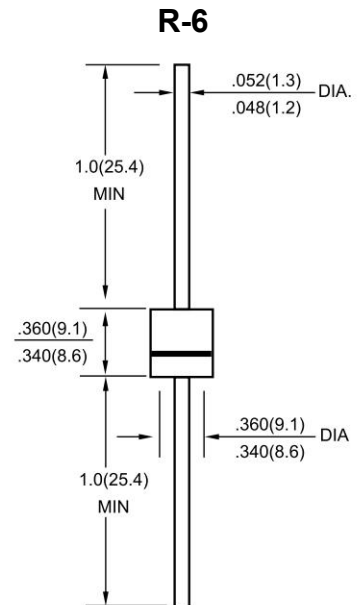


General Purpose Rectifier

Parameter	Value	Unit
V_{RRM}	50~1000	V
$I_{F(AV)}$	6.0	A

Features

- High efficiency, Low VF
- High current capability
- High reliability
- High surge current capability
- Low power loss



Dimensions in inches and (millimeters)

Electrical Characteristics (at $T_J = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	6A05	6A1	6A2	6A4	6A6	6A8	6A10	Units
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current 0.375" (9.5mm) lead length at $T_A=60^\circ\text{C}$	$I_{F(AV)}$	6.0							A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	400							A
Maximum instantaneous forward voltage at 6.0A	V_F	0.95							V
Maximum DC reverse current at rated DC blocking voltage	I_R	$T_A=25^\circ\text{C}$							μA
		$T_A=100^\circ\text{C}$							
Typical junction capacitance (NOTE ¹)	C_J	150							pF
Typical thermal resistance (NOTE ²)	$R_{\theta JA}$	10.0							$^\circ\text{C}/\text{W}$
Operating junction and storage temperature range	T_J, T_{STG}	-65 to +175							$^\circ\text{C}$

Note:

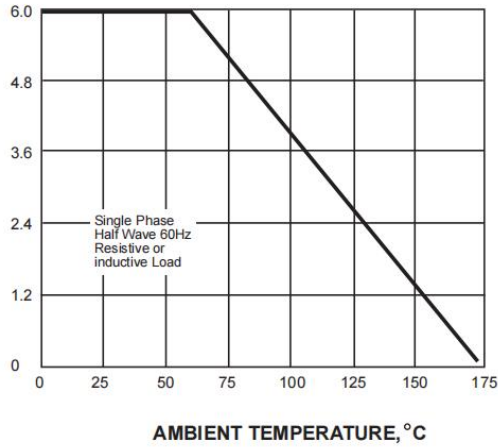
1. Measured at 1MHz and applied reverse voltage of 4.0V D.C.

2. Thermal resistance from junction to ambient at 0.375" (9.5mm) lead length, P.C.B. mounted

Typical characteristics

AVERAGE FORWARD RECTIFIED CURRENT, AMPERES

FIG. 1- FORWARD CURRENT DERATING CURVE



PEAK FORWARD SURGE CURRENT, AMPERES

FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

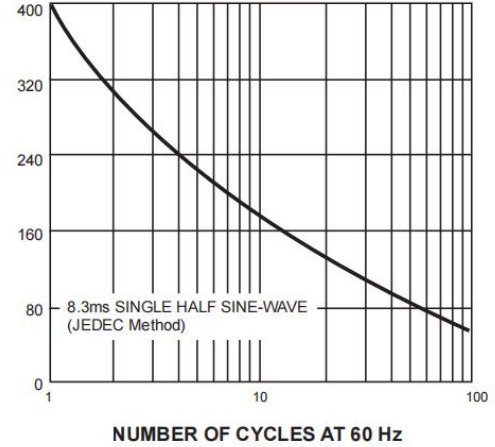
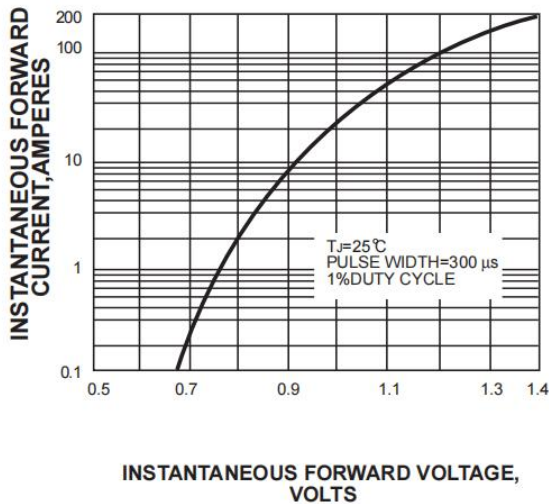


FIG. 3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS



INSTANTANEOUS REVERSE CURRENT, MICROAMPERES

FIG. 4-TYPICAL REVERSE CHARACTERISTICS

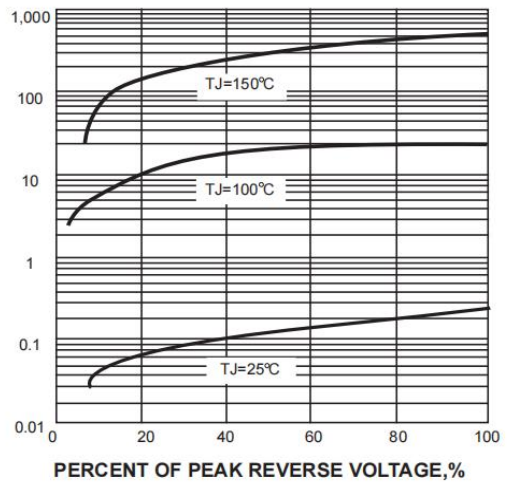
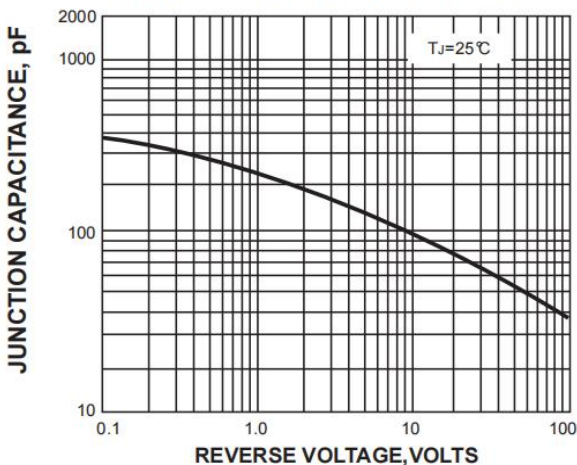
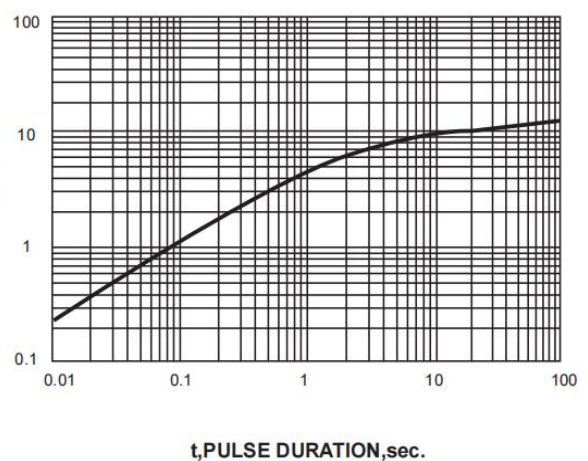


FIG. 5-TYPICAL JUNCTION CAPACITANCE



TRANSIENT THERMAL IMPEDANCE, °C/W

FIG. 6-TYPICAL TRANSIENT THERMAL IMPEDANCE



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